

View Online at <https://aerobasegroup.com/nsn/5961-01-502-6479>

Inclosure Material:

Glass and metal

Overall Length:

Between 0.168 inches and 0.200 inches

Overall Height:

Between 0.091 inches and 0.103 inches

Overall Width:

Between 0.091 inches and 0.103 inches

End Application:

Aircraft, hornet f/a-18 (e/f); central processor

Mounting Method:

Terminal

Semiconductor Material:

Silicon

Voltage Rating In Volts Per Characteristic:

400.0 working peak reverse voltage

Current Rating Per Characteristic:

2.00 amperes forward current, average and 20.00 amperes forward current, average preset

Maximum Operating Temperature Per Measurement Point:

175.0 degrees celsius ambient air

Test Data Document:

Q81349-mil-prf-19500 specification (includes engineering type bulletins, brochures, etc., that reflect specification type data in specification format; excludes commercial catalogs, industry directories, and similar trade publications, reflecting general type data on certain environmental and performance requirements and test conditions that are shown as "typical", "average", "", etc.).

Terminal Type And Quantity:

2 bonding pad

Specification Data:

81349-mil-prf-19500 government specification

Shelf Life:

N/a

Unit Of Measure:

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Demilitarization:

No

Fig:

A110a0

Mil-std (military Standard):

Mil-prf-19500 spec.